

450A 1200V Half bridge module

1 Description

These Insulated Gate Bipolar Transistor used advanced trench and Fieldstop technology design, provided excellent V_{CEsat} and switching speed ,low gate charge. Which accords with the RoHS standard.

2 Features

- FS Trench Technology, Positive temperature coefficient
- Low saturation voltage: $V_{CE(sat)}$, typ = 1.75V @ $I_c = 450A$ and $T_j = 25^\circ C$
- Extremely enhanced avalanche capability

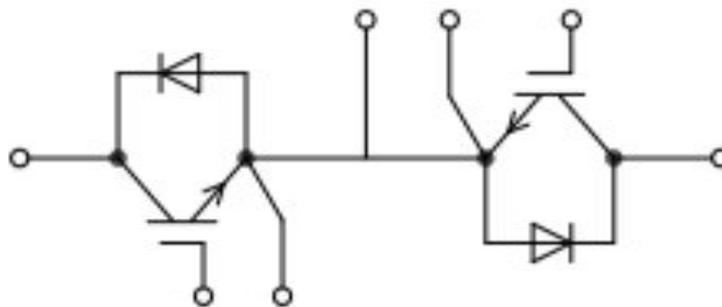
3 Applications

- Welding
- UPS
- Three-level Inverter
- AC and DC servo drive amplifier



Type	V_{CE}	I_c	$V_{CEsat}, T_j=25^\circ C$	T_{jop}	Package
DGB450H120L2T	1200V	450A ($T_j=100^\circ C$)	1.75V (Typ)	175°C	62MM

4 Equivalent Circuit Schematic



5 Electrical Characteristics

5.1 Absolute Maximum Ratings (IGBT) (Tc=25°C, unless otherwise specified)

Parameter	Symbol	Value	Units
Collector-to-Emitter Voltage	V_{CE}	1200	V
Gate-to-Emitter Voltage	V_{GE}	±20	V
DC Collector current	I_C	450	A
Pulsed Collector Current #1	I_{CM}	1200	A
$T_{vj} = 175^{\circ}\text{C}$, $V_{CC} = 800\text{V}$, $V_{GE} = 15\text{V}$, $V_{CEmax} = V_{CES} - L_{SCE} \cdot di/dt$ $T_P \leq 6 \mu\text{s}$	I_{sc}	1000	A

Notes: #1 Pulse duration is limited by $T_{j,max}$

5.2 Absolute Maximum Ratings (Diode) (Tc=25°C, unless otherwise specified)

PARAMETER	SYMBOL	VALUE	UNIT
Peak Repetitive Reverse Voltage	V_{RRM}	1200	V
DC Blocking Voltage	V_R	1200	V
Average Rectified Forward Current	$I_{F(AV)}$	400	A
Repetitive Peak Surge Current	I_{FRM}	900	A
I^2t -value	I^2t	3600	A

5.3 IGBT Module

Parameter	Symbol	VALUE	Units
Junction Temperature Range	T_{jmax}	-40~175	°C
Operating Junction Temperature	T_{jop}	-40~150	°C
Storage Temperature Range	T_{stg}	-40~120	°C
Isolation Voltage $R_{MS}, f=50\text{Hz}, t=1\text{min}$	V_{ISO}	4000	V

5.4 Thermal Characteristics (IGBT Module)

Parameter	Symbol	Rating	Units
Thermal Resistance Junction to Case	IGBT	0.105	°C/W
	Diode	0.14	

5.5 Module characteristics

Parameter	Symbol	Conditions	VALUE	Units
Material of module baseplate			Cu+Ni	
Internal isolation		Basic insulation	Improved Al2O3ceramic	
Mounting torque of screws to heat sink	Ms	M5	3.0-6.0	N·m
Mounting torque of screws to terminals	Mt	M6	2.5-5.0	N·m
Comperative tracking index	C_{TI}		>175	
Stray inductance module	L_{SCE}		25	nH

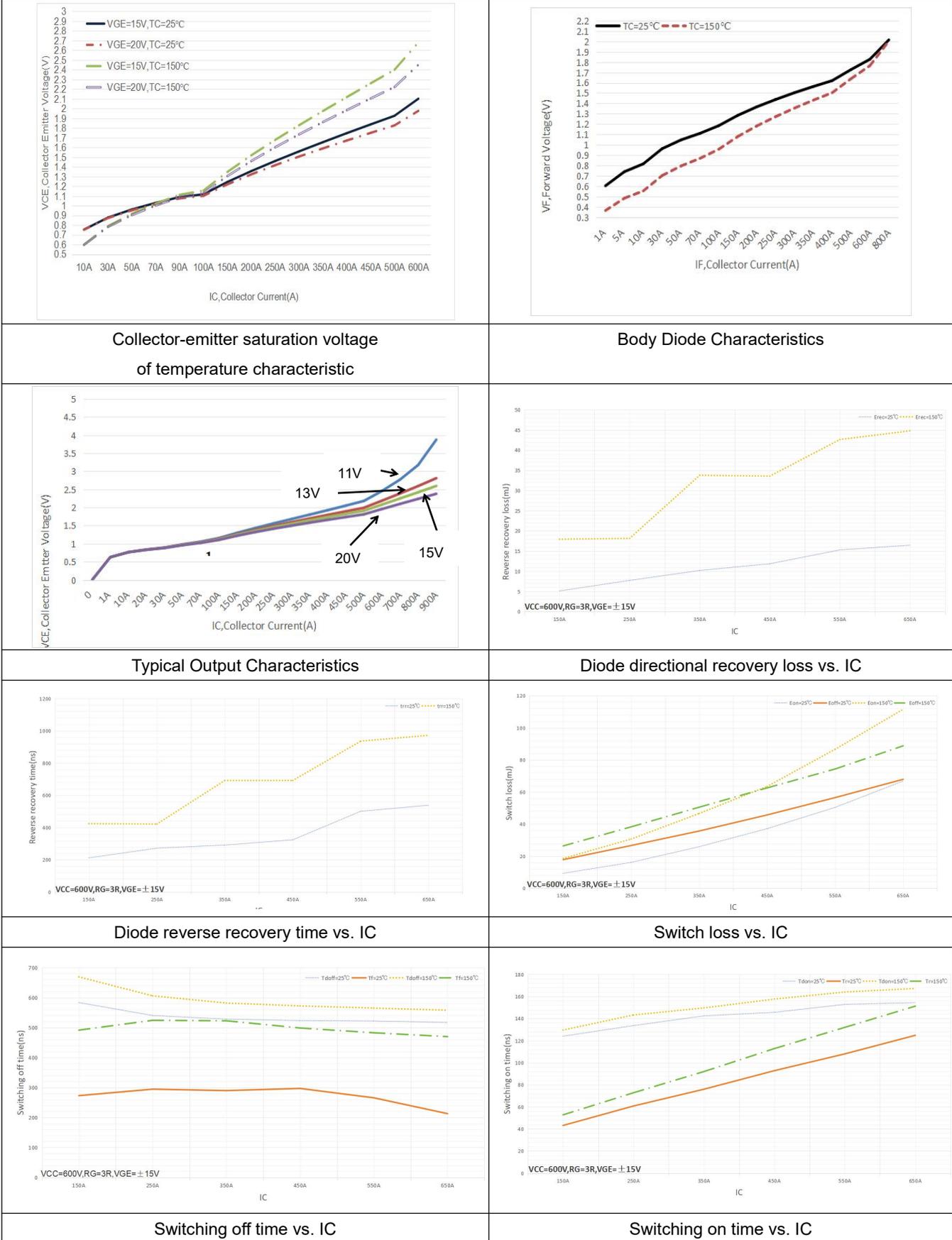
5.5 Electrical Characteristics (IGBT) (Tc=25°C, unless otherwise specified)

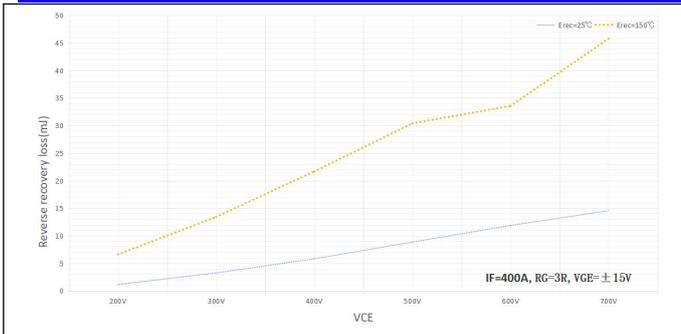
Parameter	Symbol	Conditions	Value			Units
			Min	Typ	Max	
Static Characteristics						
Collector-to-Emitter Breakdown Voltage	$V_{(BR)CES}$	$I_C=250\mu A, V_{GE}=0V, T_j=25^\circ C$	1200	--	--	V
Collector-to-Emitter Leakage Current	I_{CES}	$V_{CE}=1200V, V_{GE}=0V, T_j=25^\circ C$	--	--	100	μA
		$V_{CE}=1200V, V_{GE}=0V, T_j=150^\circ C$	--	--	5.0	mA
Gate-to-Emitter Leakage	I_{GES}	$V_{GE}=\pm 20V, V_{CE}=0V, T_j=25^\circ C$	--	--	± 100	nA
Gate Threshold Voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}, I_C=6mA$	5.0	5.6	6.0	V
Collector-emitter saturation voltage	V_{CEsat}	$V_{GE}=15V, I_C=450A, T_j=25^\circ C$	--	1.75	--	V
		$V_{GE}=15V, I_C=450A, T_j=150^\circ C$	--	2.20	--	V
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{CE}=25V, V_{GE}=0V, f=100kHz, T_a=25^\circ C$	--	72	--	nF
Output Capacitance	C_{oss}		--	3.8	--	
Reverse Transfer Capacitance	C_{rss}		--	0.42	--	
IGBT Characteristics						
Turn-on delay time	$t_{d(on)}$	$V_{CE}=600V, I_C=450A, R_g=5.1\Omega, V_{GE}=15V, \text{感性负载}, T_j=25^\circ C$	--	267.2	--	nS
Rise time	t_r		--	76	--	nS
Turn-off delay time	$t_{d(off)}$		--	690	--	nS
Fall time	t_f		--	272	--	nS
Turn-on energy	E_{on}		--	20.7	--	mJ
Turn-off energy	E_{off}		--	53.5	--	mJ
Total switching energy	E_{ts}		--	74.2	--	mJ
Turn-on delay time	$t_{d(on)}$	$V_{CE}=600V, I_C=450A, R_g=5.1\Omega, V_{GE}=15V, \text{感性负载}, T_j=150^\circ C$	--	240.8	--	nS
Rise time	t_r		--	99.2	--	nS
Turn-off delay time	$t_{d(off)}$		--	749.5	--	nS
Fall time	t_f		--	447.2	--	nS
Turn-on energy	E_{on}		--	38.9	--	mJ
Turn-off energy	E_{off}		--	70.3	--	mJ
Total switching energy	E_{ts}		--	109.2	--	mJ
Gate charge	Q_g	$V_{CE}=600V, V_{GE}=-15V \text{ to } 15V$	--	7.1	--	μC

5.6 Electrical Characteristics (Diode) (Tc=25°C, unless otherwise specified)

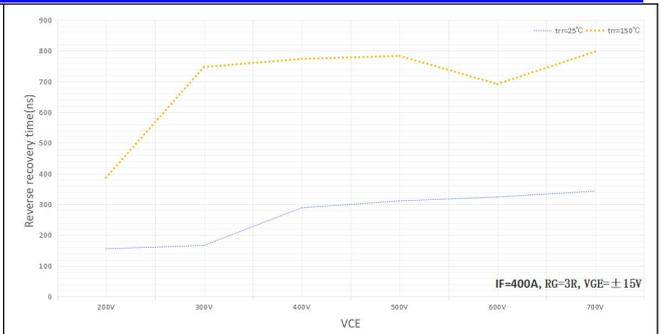
Parameter	Symbol	Conditions	Value			Units
			Min	Typ	Max	
Diode forward voltage	V_F	$I_F=450A, T_j=25^\circ C$	--	1.75	--	V
		$I_F=450A, T_j=150^\circ C$	--	1.8	--	V
Diode reverse recovery time	t_{rr}	$T_{vj}=25^\circ C, V_{CC}=600V, I_C=450A, V_{GE}=-15/15V, R_{G(on)}=5.1\Omega,$	--	560	--	ns
Diode peak reverse recovery current	I_{rrm}		--	133	--	A
Diode reverse recovery charge	Q_{rr}		--	33	--	μC
Reverse recovery energy	E_{rec}		--	10.6	--	mJ
Diode reverse recovery time	t_{rr}	$T_{vj}=150^\circ C, V_{CC}=600V, I_C=450A, V_{GE}=-15/15V, R_{G(on)}=5.1\Omega,$	--	1000	--	ns
Diode peak reverse recovery current	I_{rrm}		--	173	--	A
Diode reverse recovery charge	Q_{rr}		--	96	--	μC
Reverse recovery energy	E_{rec}		--	30.9	--	mJ

6 Typical Characteristic Curves

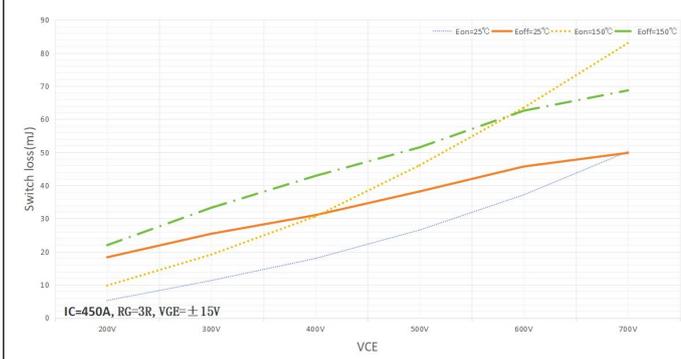




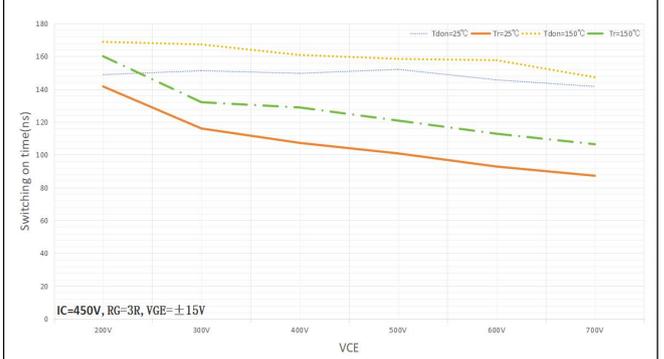
Diode directional recovery loss vs. VCE



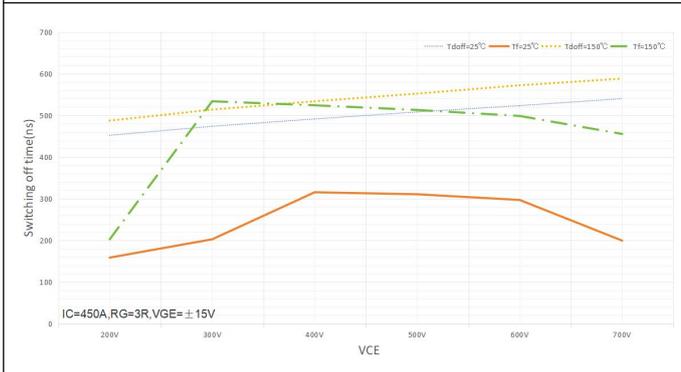
Diode reverse recovery time vs. VCE



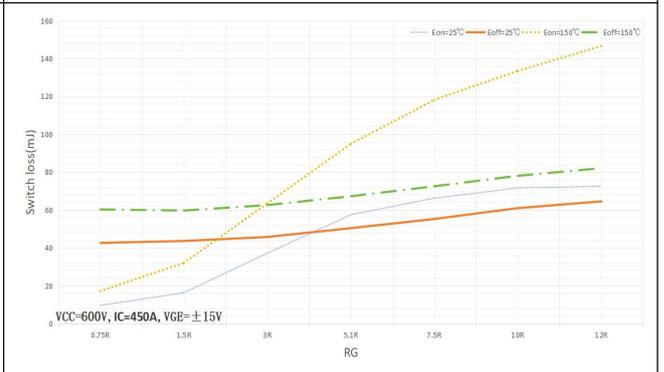
Switch loss vs. VCE



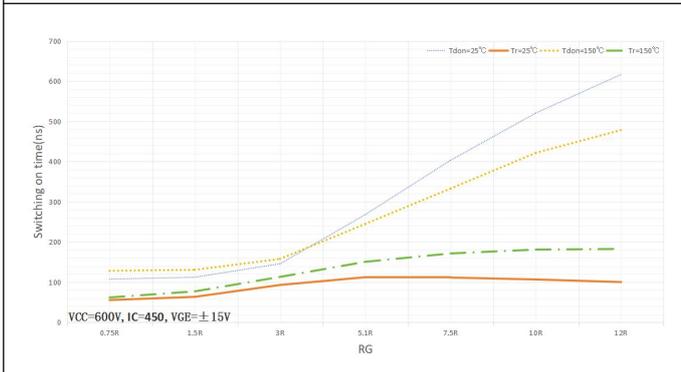
Switching on time vs. VCE



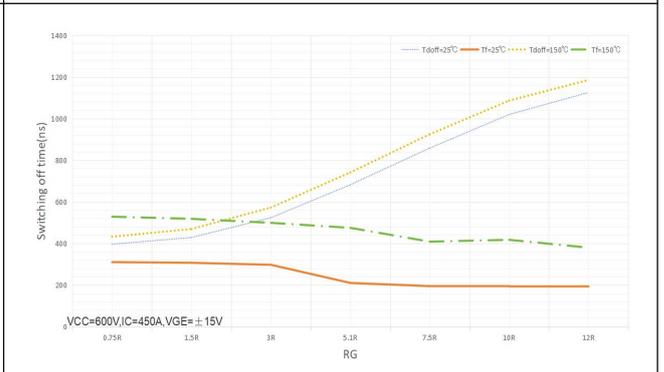
Switching off time vs. VCE



Switch loss vs. RG

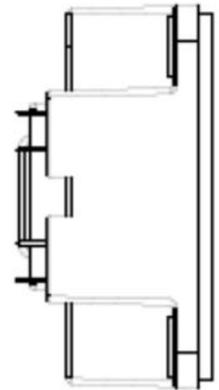
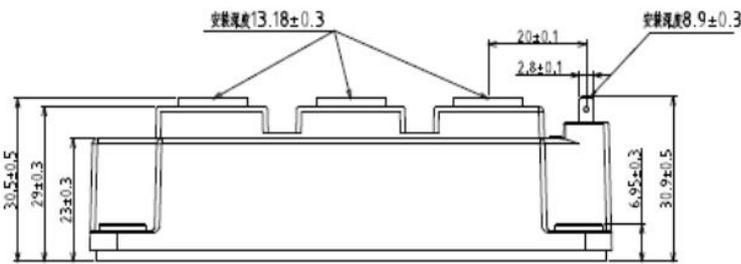
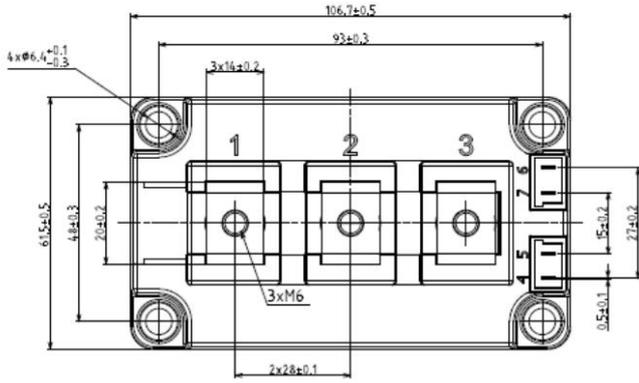


Switching on time vs. RG

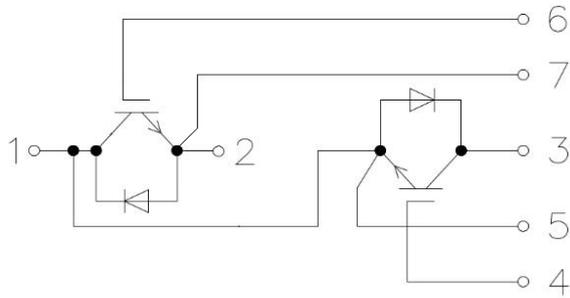


Switching off time vs. RG

7 Dimensions



7.1 Circuit Schematic



8 Attentions

- Jiangsu Donghai Semiconductor Technology CO.,LTD. reserves the right to change the specification without prior notice! The customer should obtain the latest version of the information before making the order and verify that the information is complete and up to date.
- It is the responsibility of the purchaser for any failure or failure of any semiconductor product under certain conditions. It is the responsibility of the purchaser to comply with safety standards and to take safety measures in the system design and machine manufacturing of Donghai products in order to avoid potential risk of failure. Injury or property damage.
- Product promotion is endless, our company will be dedicated to provide customers with better products.

8 Appendix

Revision history:

Date	REV.	Description	Page
2023.6.27	1.0	Original	
2024.3.30	1.1	Optimization Typical Characteristic Curves	4, 5Page